



華泰電子股份有限公司

Orient Semiconductor Electronics ,Ltd.

(股票代號 : 2329)

2026年法人說明會

INVESTOR CONFERENCE

15 MAY ,2026

Summary

Part 1 Company Profile

Part 2 Manufacture Service & Product

Part 3 2026 Q1 Financial Performance

Part 4 Competitive Advantage

Part 5 Q&A

Company Profile



公司歷史



○ 資本額 Capital : US\$ 209M(NTD6.59B)
Common Stock : US\$ 209M(NTD6.59B)

○ **2026**

55th Anniversary Celebration

○ **2015 & 2020**

Strategic Partnership Announcement

○ **2014**

1st 16D microSD in the world

○ **2005**

Biz Transformation into Memory Market

○ **Apr, 1994**

IPO in Taiwan Stock Exchange (TSE: 2329)

○ **1971 Established**

Founder : Dr. Eugene C. Y. Duh

Headquarters : Kaohsiung, Taiwan

Factory



Headquarters (Flash Memory)
(750,000 sq. ft.)

- »» 6 Production buildings in NTIP
- »» Headcount : around 5,700



Facility 2
(59,223 sq. ft.)



LIC
(256,200 sq. ft.)



Facility 3
(158,638 sq. ft.)



Facility 1
(146,475 sq. ft.)



Facility 5
(190,000 sq. ft.)

公司組織

Chairman
Tony Tung

President
C. J. Tu

Testing Group

- Memory IC Testing Service
- Logic IC Testing Service

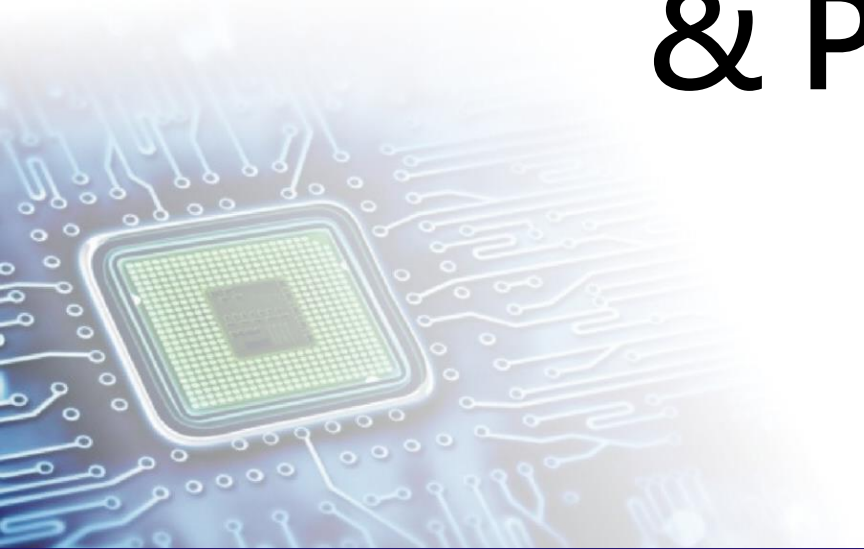
Semiconductor Group

- Memory IC Packaging Service
- Logic IC Packaging Service

EMS Group

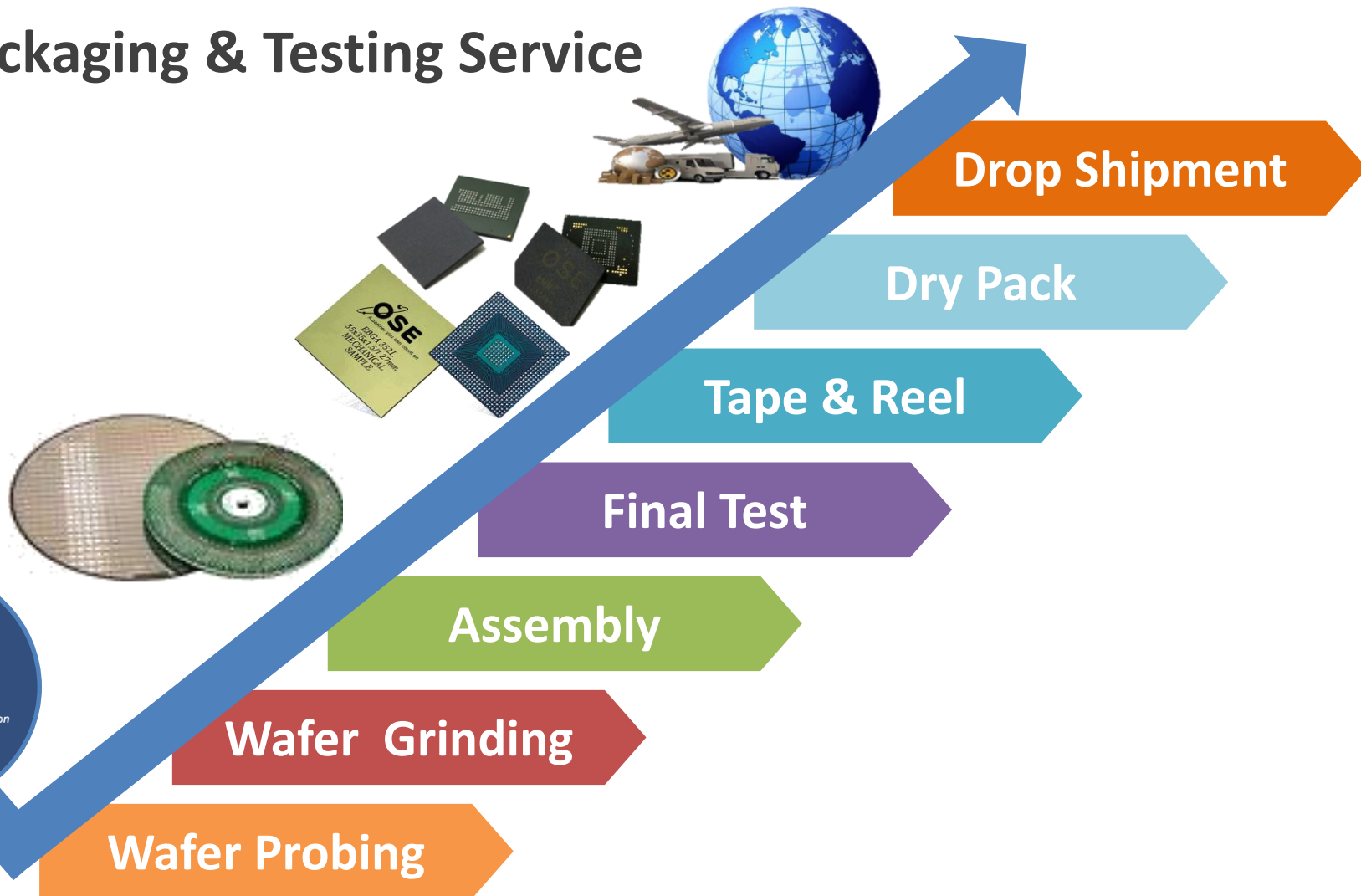
- EMS Service

Manufacture Service & Product



Total Solution

>> IC Packaging & Testing Service

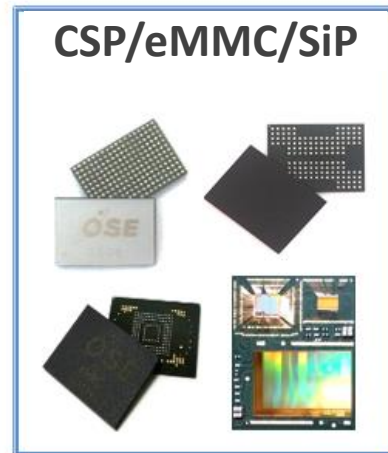
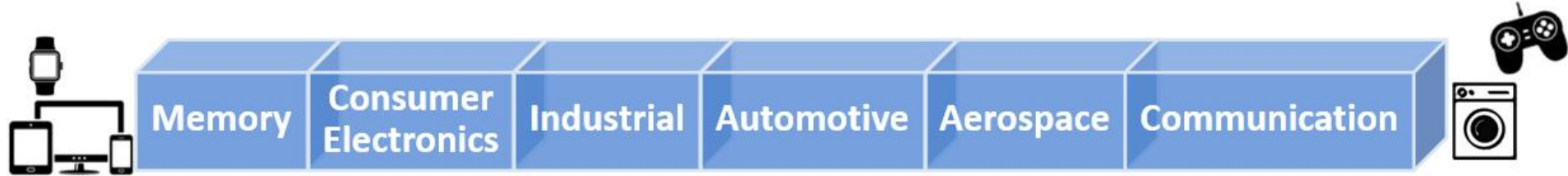


Total Solution

Electronics Manufacturing Service



Product Application



*Includes Wire Bond Type, Flip Chip Type, SiP, etc

2026 Q1

Financial Performance



CONSOLIDATED STATEMENTS OF COMPREHENSIVE INCOME (QoQ)

(Thousands of NTD)	Q1/2026	%	Q4/2025	%	Variance
Net revenue	4,860,476	100.00%	5,153,981	100.00%	(5.69%)
Gross profit	621,703	12.79%	791,370	15.35%	(21.44%)
Operating income	272,602	5.61%	422,215	8.19%	(35.44%)
Income before tax	291,646	6.00%	481,085	9.33%	(39.38%)
Income tax(expense) gains	(57,016)	(1.17%)	(77,182)	(1.50%)	(26.13%)
Non controlling interests	-	-	-	-	-
Net Income	234,630	4.83%	403,903	7.84%	(41.91%)
Basic EPS (in NTD)	0.33	-	1.04	-	-
EBITDA	592,442	12.19%	762,747	14.80%	(22.33%)

CONSOLIDATED STATEMENTS OF COMPREHENSIVE INCOME (YoY)

(Thousands of NTD)	Q1/2026	%	Q1/2025	%	Variance
Net revenue	4,860,476	100.00%	4,077,476	100.00%	19.20%
Gross profit	621,703	12.79%	538,557	13.21%	15.44%
Operating income (loss)	272,602	5.61%	196,762	4.83%	38.54%
Income (loss) before tax	291,646	6.00%	231,357	5.67%	26.06%
Income tax (expense) gains	(57,016)	(1.17%)	(44,078)	(1.08%)	29.35%
Non controlling interests	-	-	-	-	-
Net Income	234,630	4.83%	187,279	4.59%	25.28%
Basic EPS (in NTD)	0.33	-	0.27	-	22.22%
EBITDA	592,442	12.19%	473,685	11.62%	25.07%

Key Items & Index of Balance Sheet

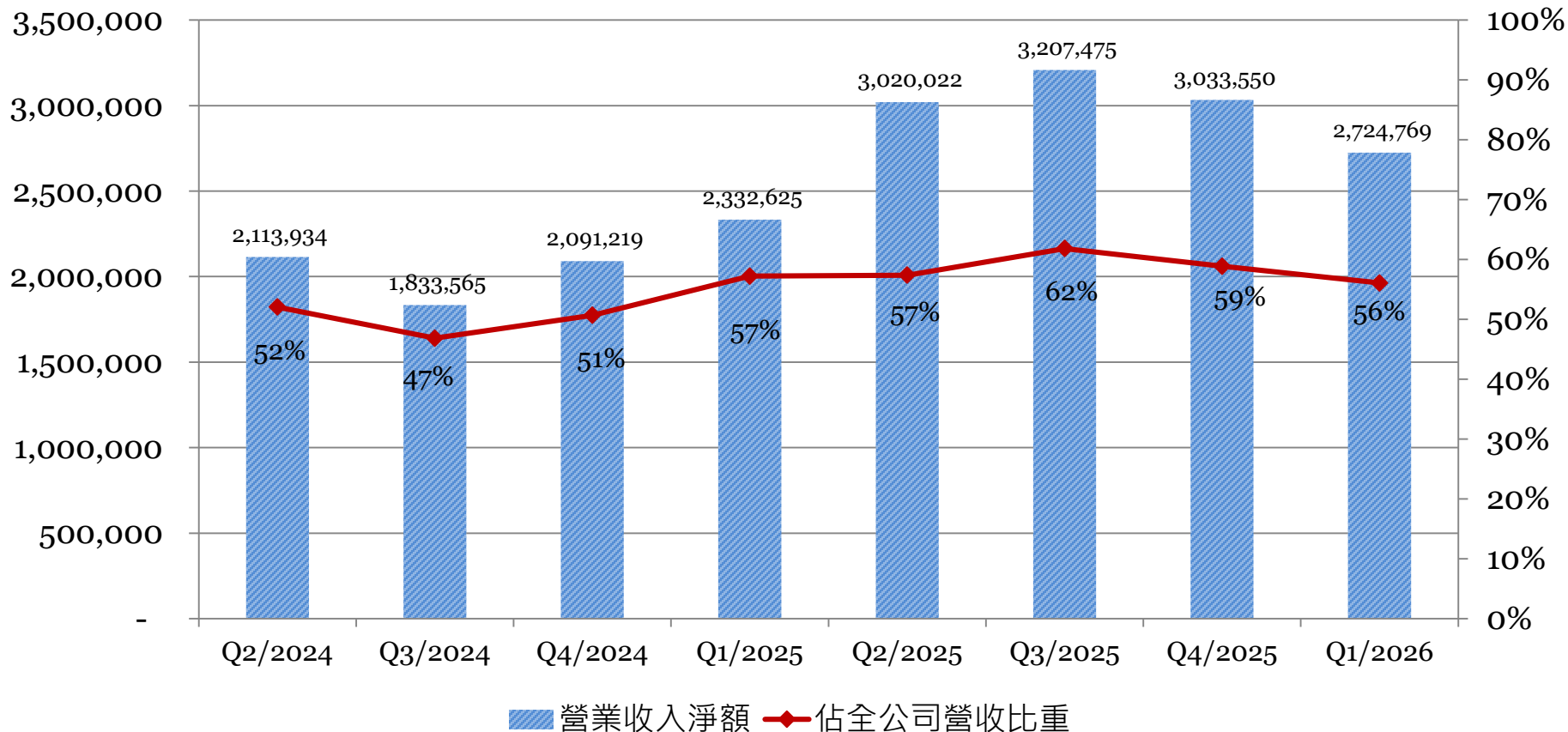
(Thousands of NTD)	Q1/2026	Q4/2025	Variance
Cash and cash equivalents	3,066,961	2,718,816	12.81%
Financial assets-Noncurrent & Investments-equity method	2,346,166	1,833,683	27.95%
Property, plant, and equipment	8,432,023	7,807,304	8.00%
Total assets	22,594,916	20,714,230	9.08%
Short-term loans & Short-term notes payable	224,000	320,704	(30.15%)
Long-Term Liabilities-Current Portion	184,002	456,432	(59.69%)
Long-term loans	228,203	1,498,454	(84.77%)
Bonds Payable	2,351,534	0	-
Total liabilities	11,149,882	9,560,032	16.63%
Total stockholders' equity	11,445,034	11,154,198	2.61%
Quarterly EBITDA	592,442	762,747	(22.33%)
Index			
Debt ratio	49.35%	46.15%	
Accounts receivable turnover days(Q1)	87 Days	78 Days	
Inventory turnover days(Q1)	59 Days	44 Days	

Key Items & Index of Balance Sheet

(Thousands of NTD)	Q1/2026	Q1/2025	Variance
Cash and cash equivalents	3,066,961	3,963,243	(22.61%)
Financial assets-Noncurrent & Investments-equity method	2,346,166	1,755,000	33.68%
Property, plant, and equipment	8,432,023	6,474,363	30.24%
Total assets	22,594,916	19,015,286	18.83%
Short-term loans & Short-term notes payable	224,000	-	100.00%
Long-Term Liabilities-Current Portion	184,002	418,997	(56.09%)
Long-term loans	228,203	928,705	(75.43%)
Bonds Payable	2,351,534	0	-
Total liabilities	11,149,882	7,937,407	40.47%
Total stockholders' equity	11,445,034	11,077,879	3.31%
	-	-	-
Quarterly EBITDA	592,442	473,685	25.07%
Index			
Debt ratio	49.35%	41.74%	
Accounts receivable turnover days(Q1~Q1)	87 Days	90 Days	
Inventory turnover days(Q1~Q1)	59 Days	43 Days	

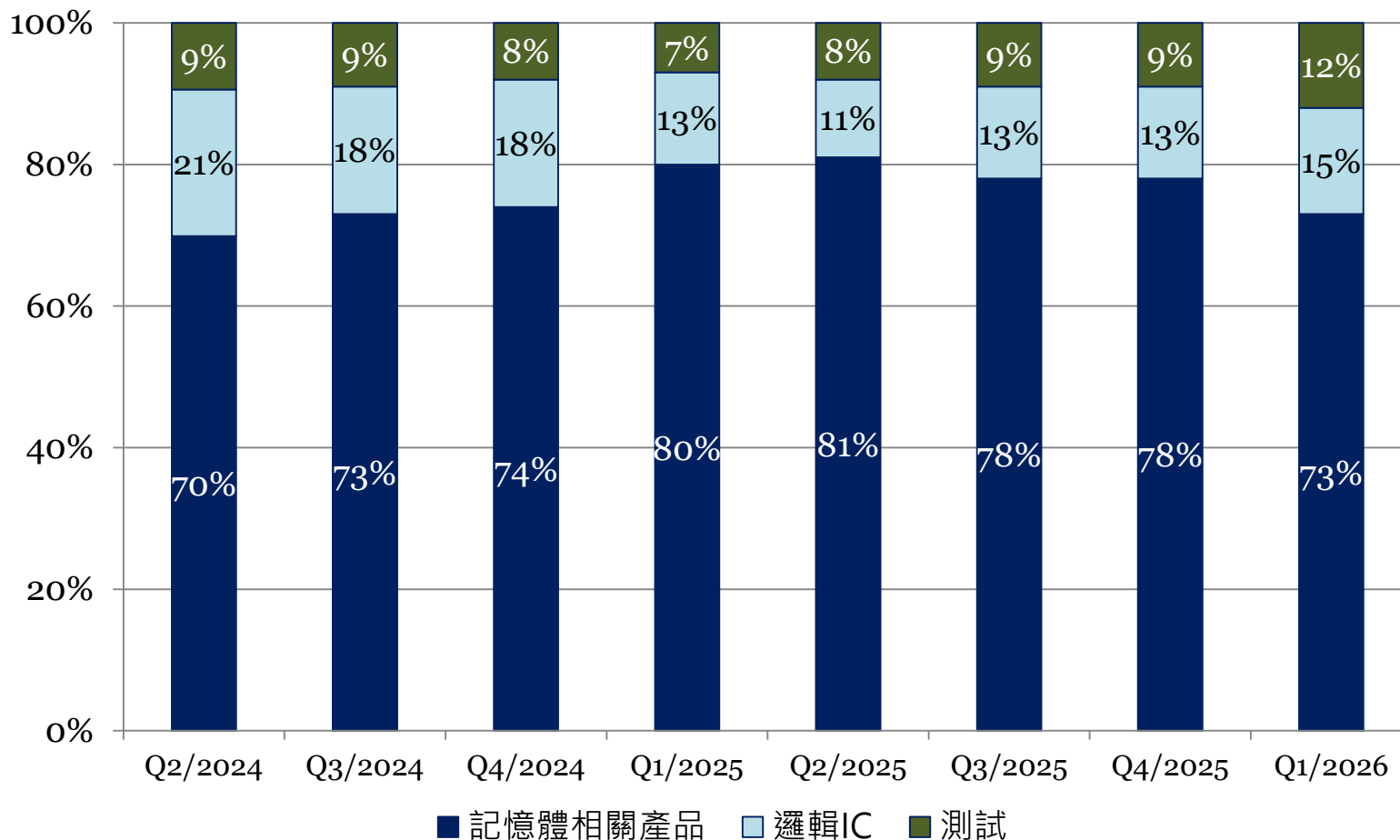
IC Packaging and Testing Services

(Thousands of NTD)



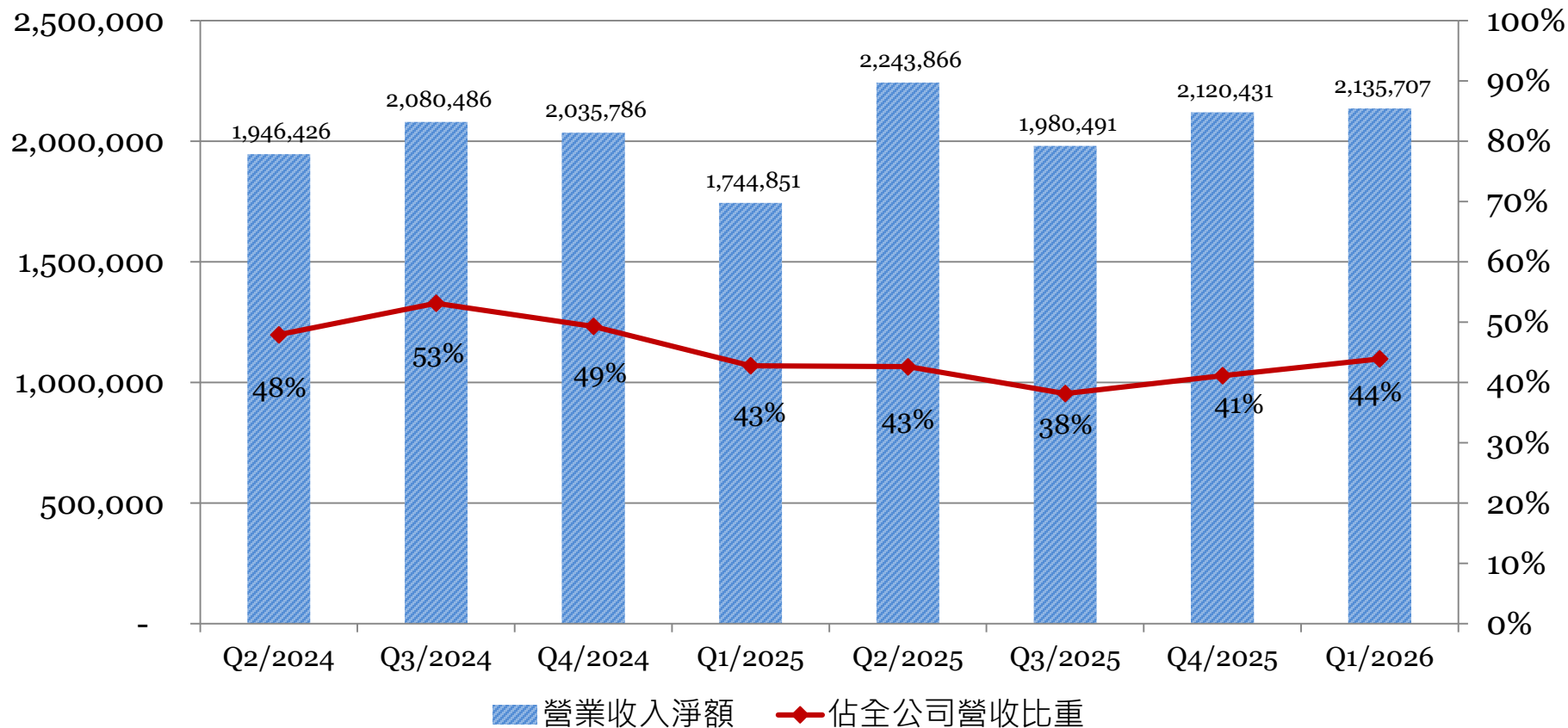
Semiconductor Group

-Percentage of revenue by product application

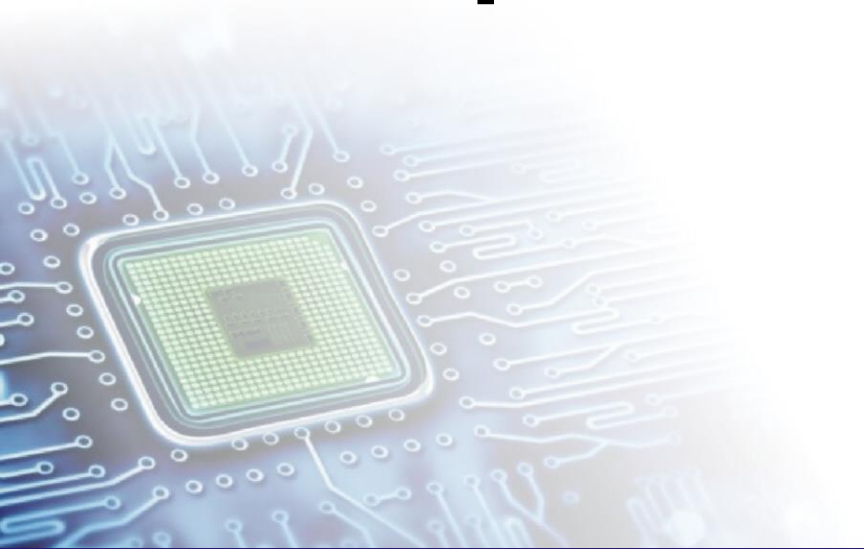


Electronics Manufacturing Services

(Thousands of NTD)



Competitive Advantage



“WHAT OSE
COULD
OFFER”

“QUALITY
SPEED
FLEXIBILITY”



- Capable of both IC & EMS / One-Stop Service.
- Sufficient experience with world-class customers. Strong Customer list.



- **Advanced Process Capability**
 - 25um wafer thickness
 - 16 Layers Die Stacking for micro SD/BGA/SD
 - Sip / Flip Chip / Wire Bond / Module Availability
 - High-end Technology

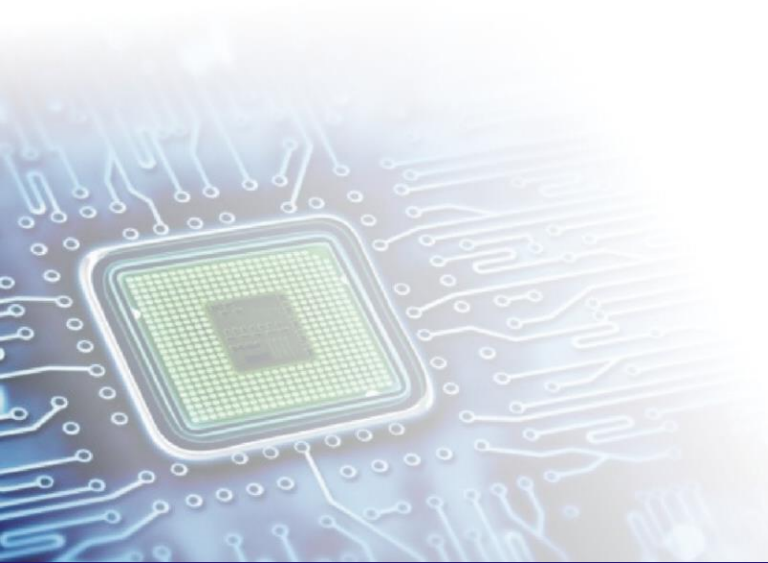


- **Digitalization**
- **MES Automation System**



- **Customer Oriented & Customization**
- **High Degree of Flexibility on capacity allocation**

Q&A



Disclaimer

The presentation and the relevant information mentioned in this material have been compiled from both internal and external resources.

These forward looking statements involve known and unknown risks, uncertainties and other factors, including price variation, competition, global economy, exchange rate movement and market demand, which may cause actual results to differ materially from those implied by such forward-looking statements.

The forward looking statements expressed in this material reflect the Company's current view about the future as of today. The Company is not responsible for any updates if there are any changes in the future.